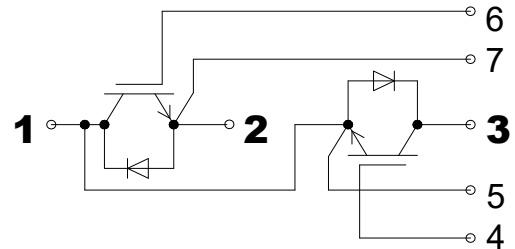


# SGG200N125UC2

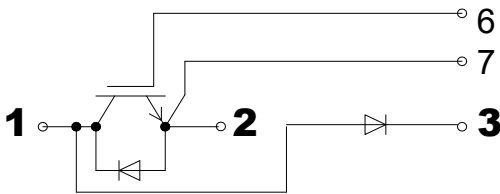
## Ultra Fast IGBT Modules



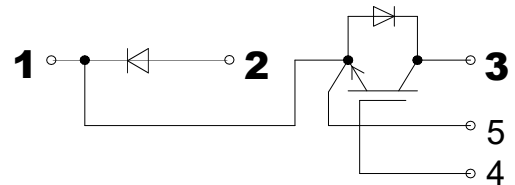
**SGG200N125UC2**



**SGD200N125UC2**



**SDG200N125UC2**



Symbol	Test Condition	Value	Unit
<b>IGBT</b>			
$V_{CES}$		1200	V
$I_C$	$T_C = 25(100)^\circ\text{C}$ per chip	200(150)	A
$V_{GES}$		$\pm 20$	V
$T_{vj}$ ( $T_{stg}$ )		$-40 \sim +150(125)$	$^\circ\text{C}$
$P_{tot}$		1270	W
<b>INVERSE DIODE</b>			
$I_F$	$T_C = 25(100)^\circ\text{C}$ per chip	200(100)	A
$I_{FM}$	$T_C = 25(100)^\circ\text{C}$ per chip	400(300)	A
$V_{RRM}$		1200	V
$I_{FSM}$	$T_j = 150^\circ\text{C}$ , $t_p = 10\text{ms}$	1450	A

# SGG200N125UC2

## Ultra Fast IGBT Modules

Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Tc = 25°C unless otherwise specified</b>					
$V_{GE(th)}$	$V_{GE}=V_{CE}$ , $I_C=6mA$	4.5	5.5	6.5	V
$I_{CES}$	$V_{GE}=0; V_{CE}=V_{CES}; T_j=25(125)^\circ C$		0.25(1.50)	0.45(2.00)	mA
$V_{CE(TO)}$	$T_j=25(125)^\circ C$		2.0(1.8)	2.5(2.3)	V
$r_{CE}$	$V_{GE}=15V$		13.0(15.0)	14.0(19.0)	mΩ
$V_{CE(sat)}$	$I_C=150A; V_{GE}=15V; \text{chip level}$		3.30	3.75	V
$C_{ies}$	$V_{GE}=0V, V_{CE}=25V, f=1MHz$		10.0	13.0	nF
$C_{oes}$			1.60	2.00	
$C_{res}$			0.80	1.20	
LCE				20	nH
RCC'+EE'	Terminal to Case , $T_c=25(125)^\circ C$		0.35(0.50)		mΩ
$t_{d(on)}$	$V_{CC} = 600V, I_C = 15. A$ $R_{GON} = R_{GOFF} = 4\Omega$ $T_j=125^\circ C$ $V_{GE}=\pm 15V$		75		ns
$t_r$			35		ns
$t_{d(off)}$			410		ns
$t_f$			24		ns
$E_{on}/E_{off}$				14.0/8.0	
<b>INVERSE DIODE</b>					
<b>Tc = 25°C unless otherwise specified</b>					
$V_F$	$I_F = 150A; V_{GE}=0V; T_j = 25^\circ C$		1.9	2.5	V
$Q_{rr}$	$I_F=150A; V_R=300V;$ $T_j=25^\circ C \text{ di/dt} = 600A/us,$ $V_{GE}=-15V$		8.5		μC
$I_{RRM}$			55		A
$E_{rec}$			12.0		mJ
<b>THERMAL CHARACTERISTICS</b>					
$R_{th(j-c)}$	per IGBT			0.095	K/W
$R_{th(j-c)D}$	per FRD			0.250	K/W
<b>Mechanical Data</b>					
Ms		2.5		5	Nm
Weight			320		g

### Features

- NPT Technology IGBT
- Fast Recovery Free Wheeling Diode
- Low Switching Losses
- $V_{ce(sat)}$  with positive temperature coefficient
- Fast Switching and short tail current
- Switched mode power supplies at  $f_{sw}>20KHz$
- Resonant inverters up to 100KHz
- Electronic Welders at  $f_{sw}>20KHz$

### Application

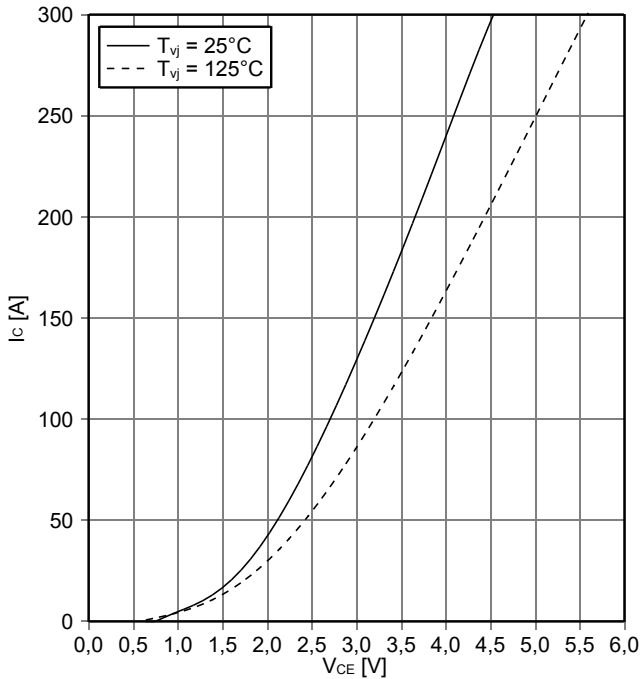
- Welding inverters
- Inductive Heating

### Advantages

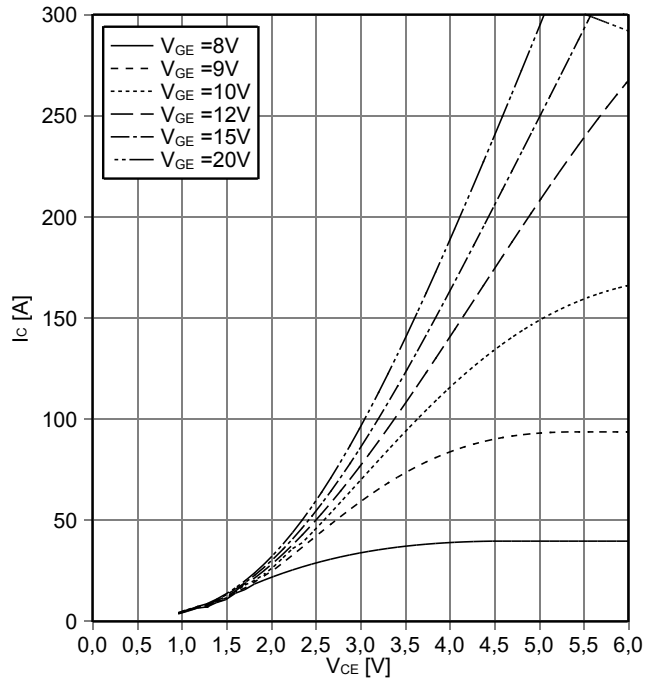
- Space and weight savings
- Reduced protection circuits

# SGG200N125UC2

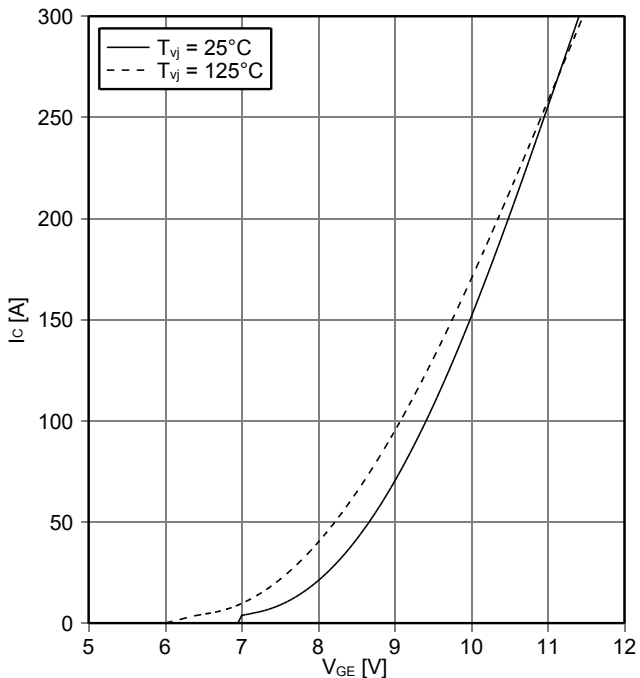
## Ultra Fast IGBT Modules



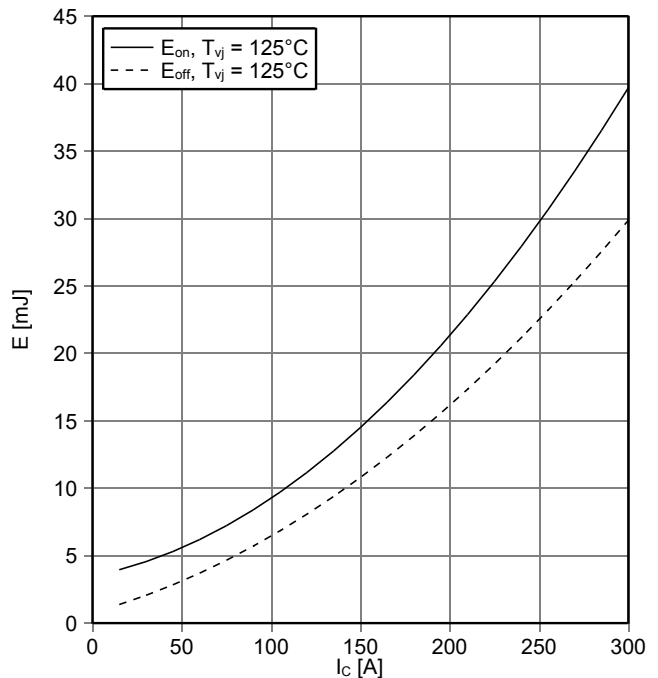
**Output characteristic IGBT, Inverter (typical)**  
 $I_c = f(V_{CE}), V_{GE} = 15\text{ V}$



**Output characteristic IGBT, Inverter (typical)**  
 $I_c = f(V_{CE}), T_{vj} = 125^\circ\text{C}$



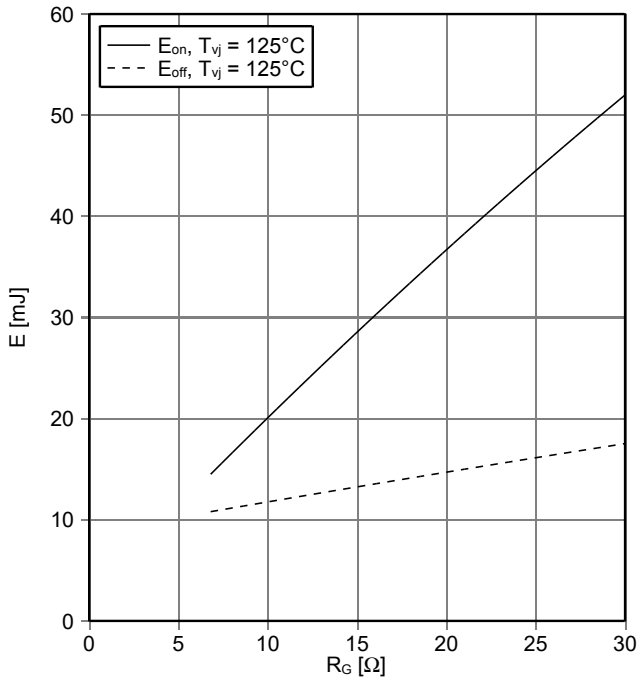
**Transfer characteristic IGBT, Inverter (typical)**  
 $I_c = f(V_{GE}), V_{CE} = 20\text{ V}$



**Switching losses IGBT, Inverter (typical)**  
 $E_{on} = f(I_c), E_{off} = f(I_c)$   
 $V_{GE} = \pm 15\text{ V}, R_{Gon} = 6.8\ \Omega, R_{Goff} = 6.8\ \Omega, V_{CE} = 600\text{ V}$

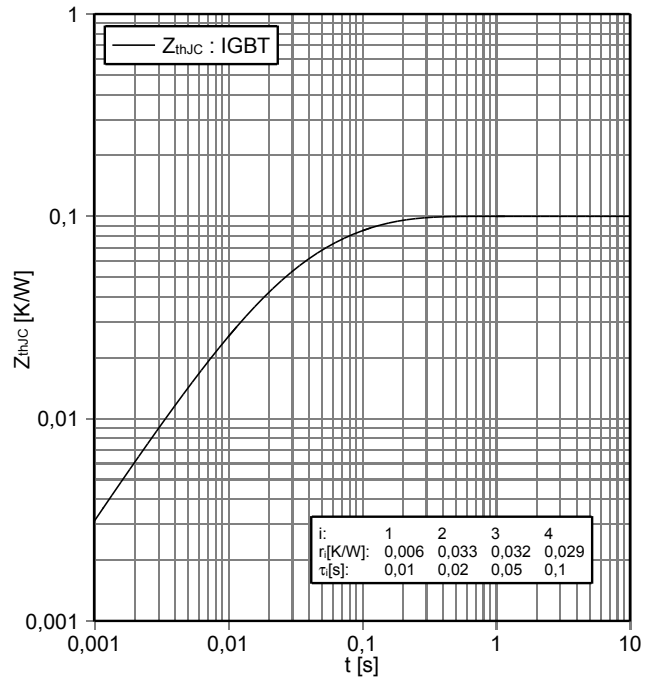
# SGG200N125UC2

## Ultra Fast IGBT Modules



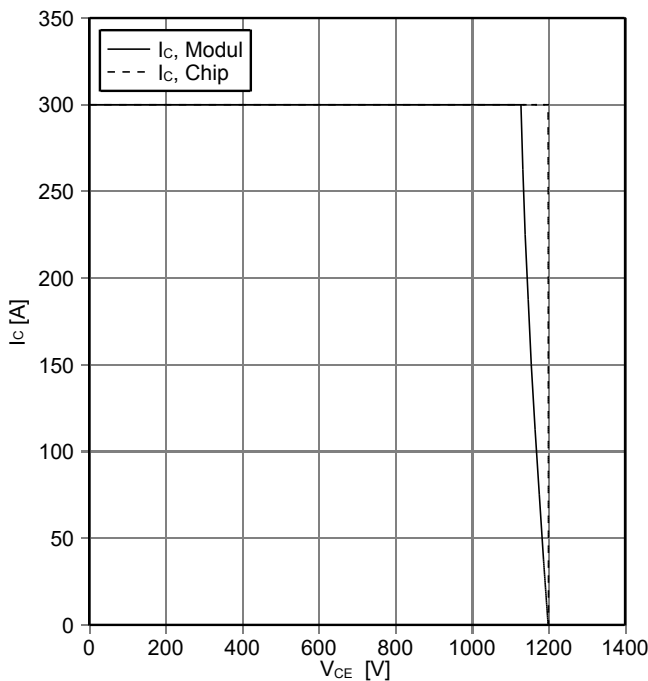
**Switching losses IGBT, Inverter (typical)**

$E_{on} = f(R_G), E_{off} = f(R_G)$   
 $V_{GE} = \pm 15 V, I_C = 150 A, V_{CE} = 600 V$



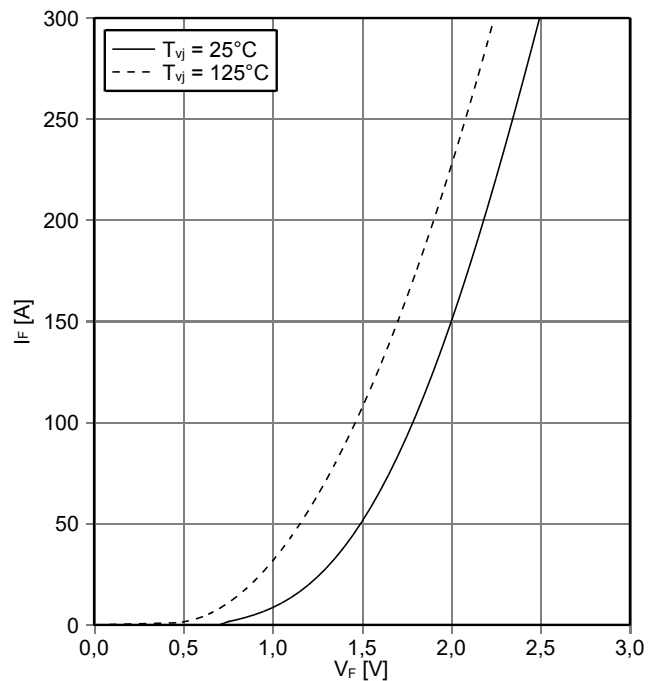
**Transient thermal impedance IGBT, Inverter**

$Z_{thJC} = f(t)$



**Reverse bias safe operating area IGBT, Inverter**

**(RBSOA)**  $I_C = f(V_{CE})$   
 $V_{GE} = \pm 15 V, R_{Goff} = 6.8 \Omega, T_{vj} = 125^{\circ}C$

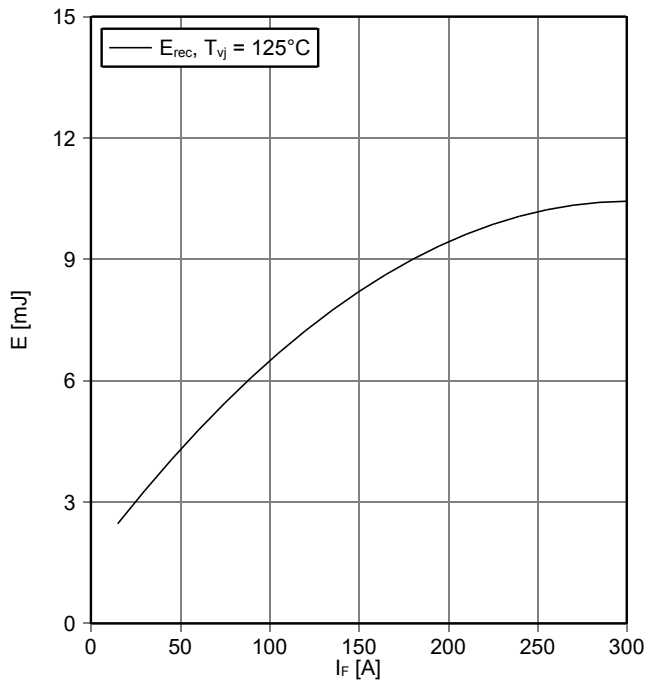


**Forward characteristic of Diode, Inverter (typical)**

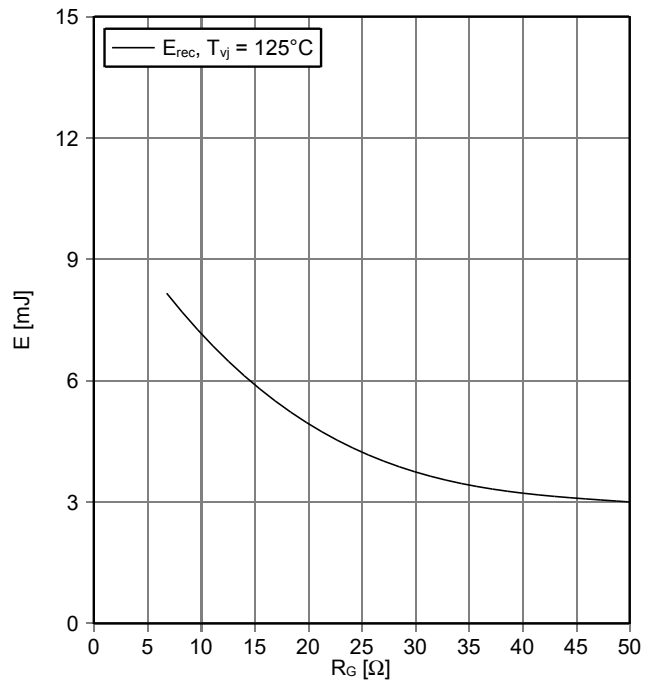
$I_F = f(V_F)$

# SGG200N125UC2

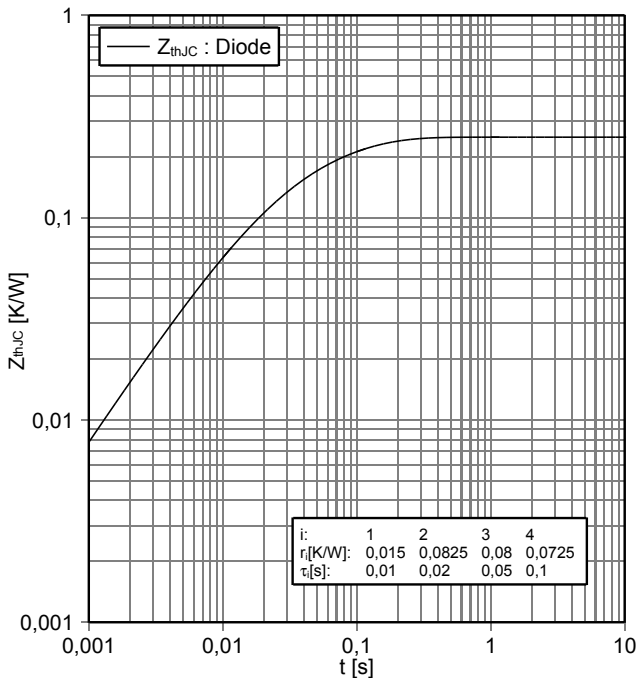
## Ultra Fast IGBT Modules



**Switching losses Diode, Inverter (typical)**  
 $E_{rec} = f(I_F)$   
 $R_{Gon} = 6.8 \Omega, V_{CE} = 600 V$



**Switching losses Diode, Inverter (typical)**  
 $E_{rec} = f(R_G)$   
 $I_F = 150 A, V_{CE} = 600 V$



**Transient thermal impedance Diode, Inverter**  
 $Z_{thJC} = f(t)$

i:	1	2	3	4
r <sub>i</sub> [K/W]:	0,015	0,0825	0,08	0,0725
τ <sub>i</sub> [s]:	0,01	0,02	0,05	0,1

# SGG200N125UC2

Ultra Fast IGBT Modules

